



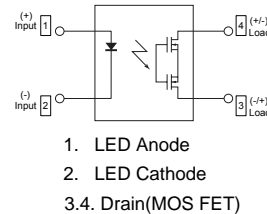
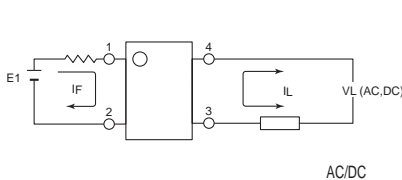
APSEMI

1 Form B APY414E_EH
DIP-4 SMD-4 Load Voltage:400V Load Current:0.12A

Parameter	Symbol	Rating	Units
Load Voltage	V_L	400	V
Load Current	I_L	0.12	A
On-Resistance	R_{on}	20	Ω
I/O Breakdown Voltage	V_{io}	5000	Vrms



E534710



DIP-4



SMD-4

APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power.

While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

- Long life (No limit on mechanical and electrical lifetime)
- Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI
- No have voltaic arc, bounce, and noise
- More resistant to vibration and impact
- AC or DC load switching
- Small package size

Function

APSEMI PhotoRelays operate by taking a low level input current (<5mA) that energizes an input Infrared LED, which is optically-coupled to a Photo-diode array chip. This IC in turn generates a photo voltage that powers two MOSFETs typically connected in a source-to-source configuration, allowing for both AC and DC output loads. Photorelay basically move photons to accomplish their switching function, they incur no mechanical wear and tear, providing consistent reliable switching.

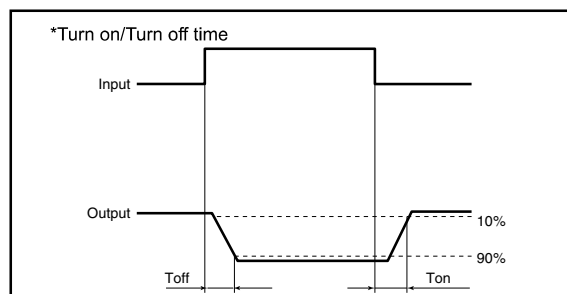
Applications

These advantages make APSEMI Photorelays the ideal choice for:

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems
- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Category	Output rating		Package	Part No.	Packing quantity
	Load voltage	Load current			
AC/DC	400V	0.12A	DIP-4	APY414E	50pcs/tube
			SMD-4	APY414EH	1000pcs/1reel





Absolute Maximum Ratings (Ta = 25°C)

	Item	Symbol	Value	Units	Note
Input	Continuous LED Current	I_F	50	mA	
	Peak LED Current	I_{FP}	500	mA	f=100Hz, duty=1%
	LED Reverse Voltage	V_R	5	V	
	Input Power Dissipation	P_{in}	75	mW	
Output	Load Voltage	V_L	400	V(AC peak or DC)	
	Load Current	I_L	0.12	A	
	Peak Load Current	I_{Peak}	0.3	A	100ms(1 pulse)
	Output Power Dissipation	P_{out}	500	mW	
Total Power Dissipation		P_T	550	mW	
I/O Breakdown Voltage		$V_{I/O}$	5000	Vrms	RH=60%, 1min
Operating Temperature		T_{opr}	-40 to +85	°C	
Storage Temperature		T_{stg}	-40 to +100	°C	
Pin Soldering Temperature		T_{sol}	260	°C	10 sec max.

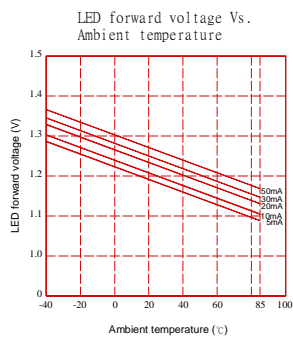
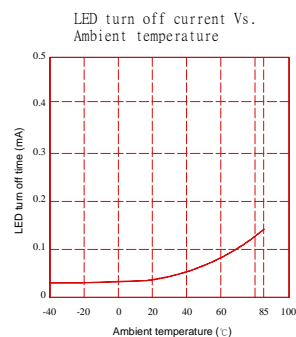
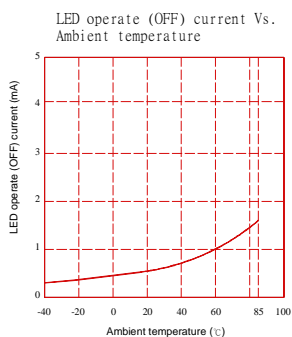
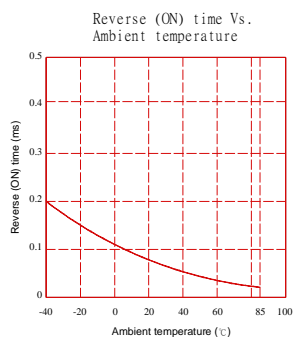
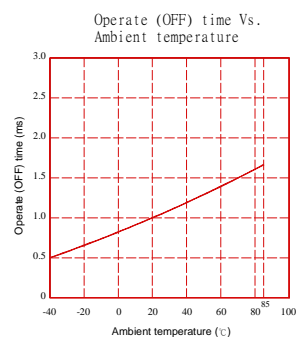
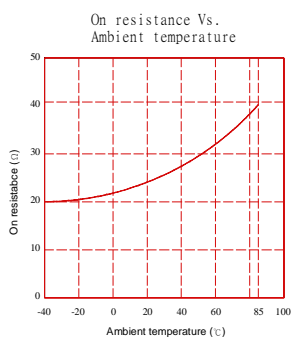
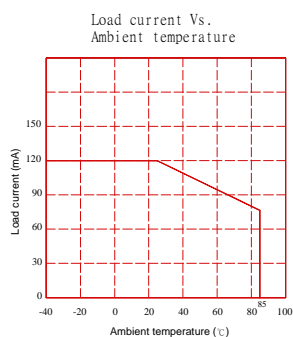
Electrical Specifications (Ambient Temperature: 25°C)

	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	V_F		1.2	1.4	V	$I_F=10mA$
	Operation LED Current	$I_{F on}$		0.5	3.0	mA	
	Recovery LED Current	$I_{F off}$		0.35	0.5	mA	
	Recovery LED Voltage	$V_{F off}$	0.5			V	
Output	On-Resistance	R_{on}		20	50	Ω	$I_F=0mA, I_L=100mA$, Time to flow is within 1 sec.
	Off-State Leakage Current	I_{Leak}			1.0	μA	$V_L=Rating$
	Output Capacitance	C_{out}		165		pF	$V_L=0, f=1MHz$
Transmis sion	Turn-On Time	T_{on}		0.02	1.0	ms	$I_F=5mA, I_L=100mA$,
	Turn-Off Time	T_{off}		0.5	3.0	ms	
Coupled	I/O Isolation Resistance	$R_{I/O}$	10^{10}			Ω	DC500V
	I/O Capacitance	$C_{I/O}$		0.8	1.5	pF	f=1MHz

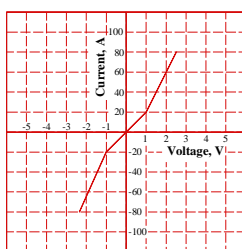
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): $I_F \geq 5mA$ and $\leq 30mA$



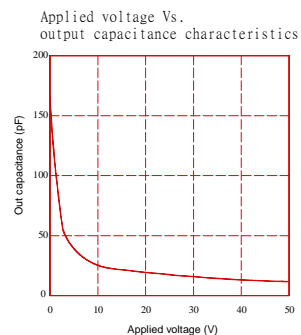
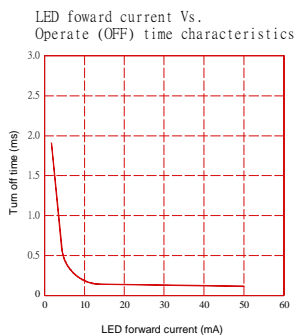
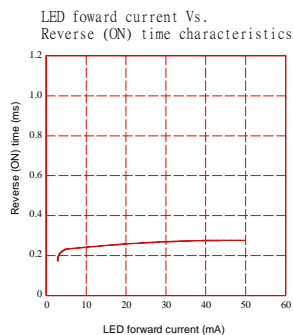
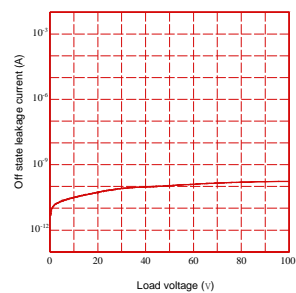
Engineering Data



Voltage Vs. current characteristics of output at MOS portion



Off state leakage current Vs. Load voltage characteristics



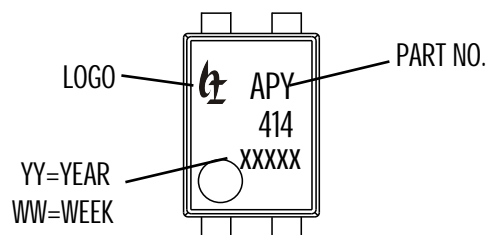


APSEMI

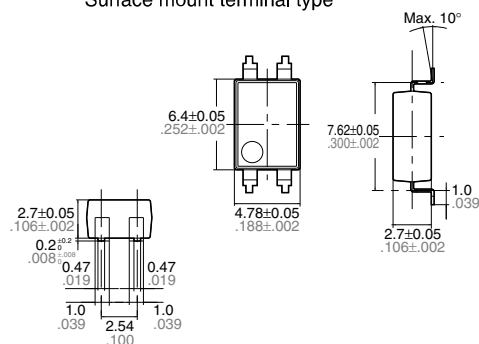
1 Form B APY414E_EH
DIP-4 SMD-4 Load Voltage:400V Load Current:0.12A

Dimensions and SMD-4 Package Unit: mm

Marking

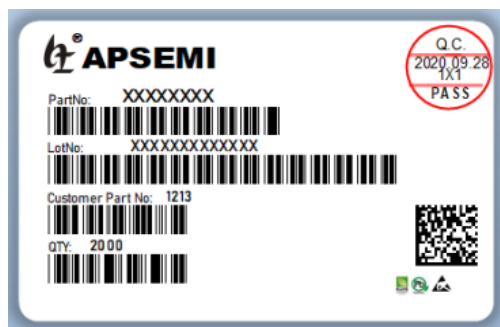


Surface mount terminal type

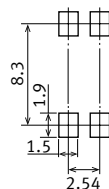


Terminal thickness: $t = 0.2$
General tolerance: ± 0.1

Lable

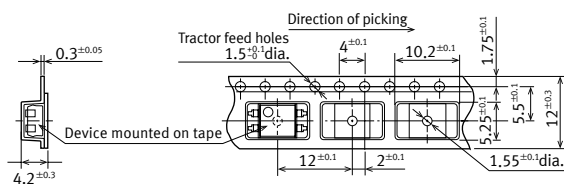
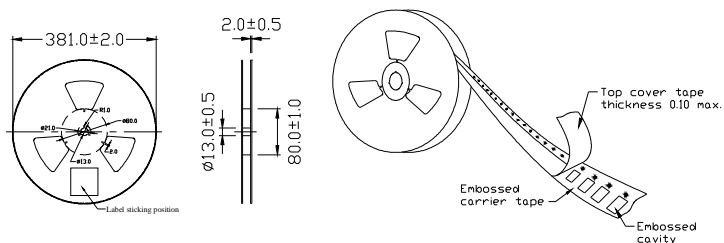


Recommended mounting pad (TOP VIEW)



Tolerance: ± 0.1

Tape dimensions (tape reel)



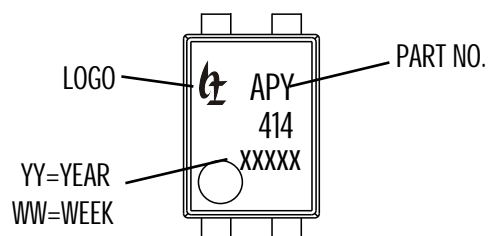


APSEMI

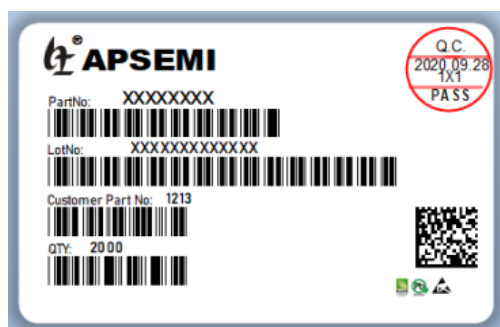
1 Form B APY414E_EH
DIP-4 SMD-4 Load Voltage:400V Load Current:0.12A

Dimensions and DIP-4 Package Unit: mm

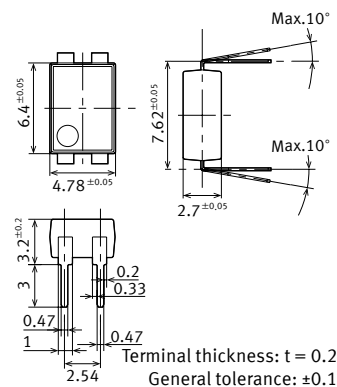
Marking



Lable

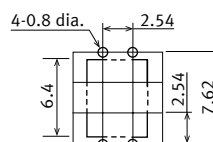


Surface mount terminal type



PC board pattern

(BOTTOM VIEW)

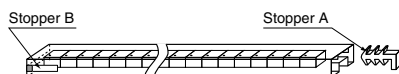


Tolerance: ±0.1

Tape dimensions (tape reel)

DIP type

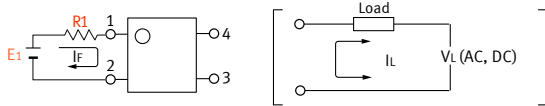
Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.





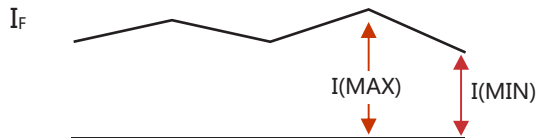
Using Methods

Examples of resistance value to control LED forward current ($I_F=5\text{mA}$)



E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9K Ω
24V	4.1K Ω

LED forward current must be more than 5mA , at $I(\text{MIN})$,and less than 30mA , at $I(\text{MAX})$.



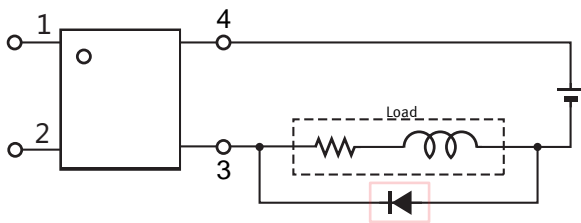
Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

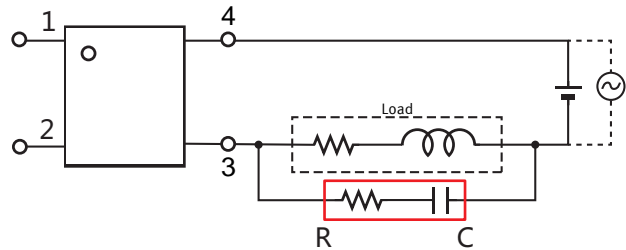
Characteristic	Symbol	Min	Typ.	Max	Unit
Forward current	I_F	5.0	7.0	30	mA

Protection Circuit

Clamp diode is connected in parallel with the load.
Absorb capacity with external diode.



CR Snubber is connected in parallel with the load.
Absorb capacity with buffer capacity.



When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective.
Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.



RESTRICTIONS ON PRODUCT USE

APSEMI Co. and its subsidiaries and affiliates (collectively "APSEMI") reserve the right to make changes to all information contained in this document relating to hardware, software, and systems (collectively "Products").

No information in this document may be reproduced without the prior written permission of APSEMI. Even with APSEMI's written permission, this document may only be reproduced if it is guaranteed to be unaltered or missing.

APSEMI assumes no responsibility for unintended uses of the product:

Unintended uses include, but are not limited to, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, automobiles, trains, ships, and other transportation equipment, traffic signaling equipment, equipment used for the control of combustion or explosions, safety devices, elevators and escalators, equipment used in electrical power-related applications, and equipment used in financial-related applications.

APSEMI assumes no responsibility for the product if you use it for any purpose other than the specific purpose described in this document.

- The information contained herein is provided only as a guide for the use of the product. APSEMI assumes no responsibility for infringement of third party patents or any other intellectual property rights that may result from the use of the product. This document does not grant any license, express or implied, estoppel or otherwise, to any intellectual property.

- GaAs (Gallium Arsenide) is used in products and is harmful to humans. Inadvertent ingestion or absorption of GaAs can harm the human body, so handle the product with care and do not break, cut, crush, grind, chemically dissolve, or otherwise expose GaAs in the product.

- Please be aware of environmental issues and use products in compliance with all applicable laws and regulations governing the inclusion or use of controlled substances, including but not limited to the EU RoHS Directive. APSEMI assumes no responsibility for damages or losses resulting from non-compliance with applicable laws and regulations.